

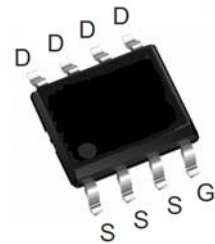
Features

- N-Channel
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5\text{ V}$
- Fast Switching
- High conversion efficiency
- Pb-free lead plating; RoHS compliant

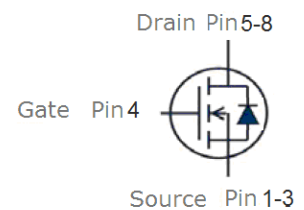


V_{DS}	100	V
$R_{DS(on),TYP}@ V_{GS}=4.5\text{ V}$	20	m Ω
I_D	9	A

SOP8



Part ID	Package Type	Marking	Tape and reel information
VS1H18AS	SOP8	1H18AS	3000pcs/reel



Maximum ratings, at $T_j=25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	100	V
I_S	Diode continuous forward current	$T_C=25^\circ\text{C}$ 9	A
I_D	Continuous drain current@ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$ 9	A
		$T_A=70^\circ\text{C}$ 6.3	A
I_{DM}	Pulse drain current tested ①	$T_C=25^\circ\text{C}$ 40	A
EAS	Avalanche energy, single pulsed ②	$I_D=16\text{A}$ 64	mJ
IAS	Avalanche energy, single pulsed ②	20	A
P_D	Maximum power dissipation	$T_A=25^\circ\text{C}$ 1.7	W
V_{GS}	Gate-Source voltage	± 20	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.6	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	72	$^\circ\text{C/W}$

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(Tc=25°C)	V _{DS} =100V,V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(Tc=125°C)	V _{DS} =100V,V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V,V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =250μA	1	1.6	3	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =10V, I _D =8A	--	19	22	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =6V, I _D =4A	--	20	24	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =4.5V, I _D =4A	--	22	26	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =25V,V _{GS} =0V, f=1MHz	--	4280	--	pF
C _{oss}	Output Capacitance		--	188	--	pF
C _{riss}	Reverse Transfer Capacitance		--	140	--	pF
Q _g	Total Gate Charge	V _{DS} =50V,I _D =4A, V _{GS} =10V	--	80	--	nC
Q _{gs}	Gate-Source Charge		--	10	--	nC
Q _{gd}	Gate-Drain Charge		--	15.5	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =50V, I _D =4A, R _G =6.8Ω, V _{GS} =10V	--	23	--	nS
t _r	Turn-on Rise Time		--	112	--	nS
t _{d(off)}	Turn-Off Delay Time		--	50	--	nS
t _f	Turn-Off Fall Time		--	100	--	nS
Source- Drain Diode Characteristics@ T_c = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	I _{SD} =8A,V _{GS} =0V	--	0.78	1.2	V
t _{rr}	Reverse Recovery Time	T _J =25°C,I _{sd} =4A, V _{GS} =0V	--	33	--	nS
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs		42		nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH,R_G = 25Ω, I_{AS} = 16A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

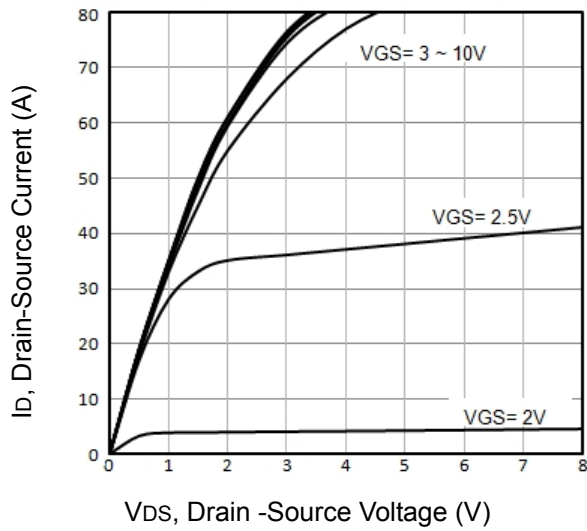


Fig1. Typical Output Characteristics

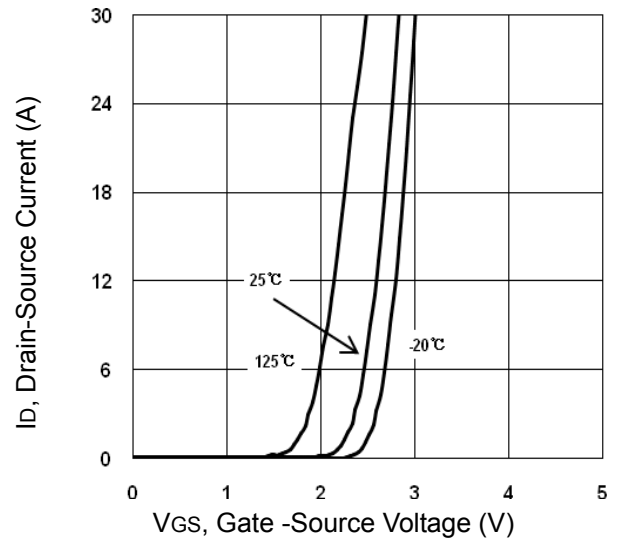


Fig2. Typical Transfer Characteristics

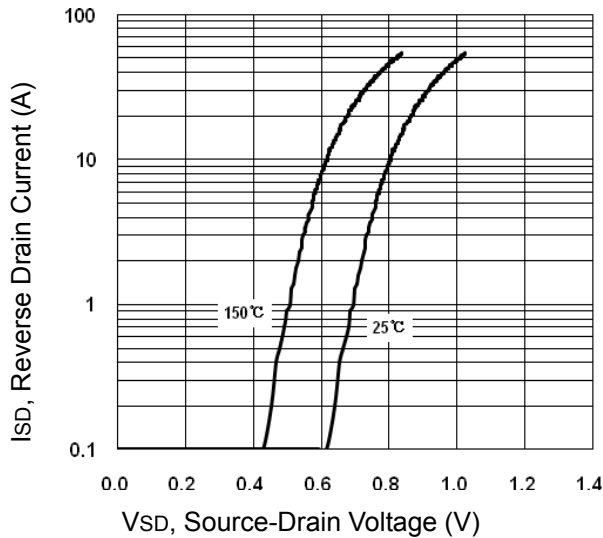


Fig3. Typical Source-Drain Diode Forward

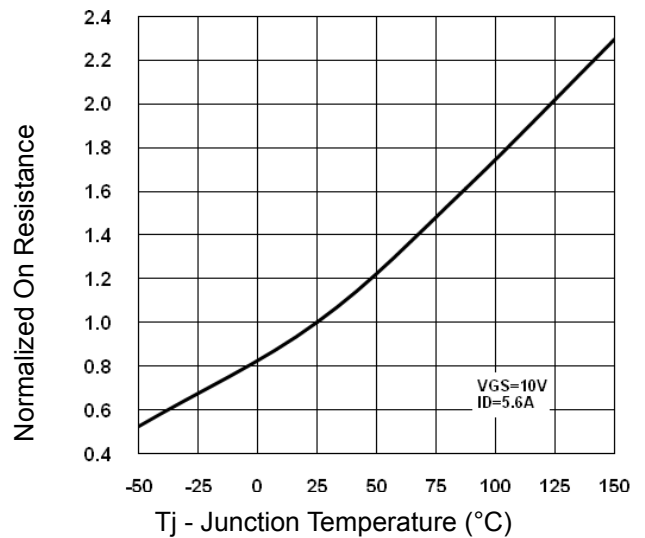


Fig4. Normalized On-Resistance Vs. Temperature

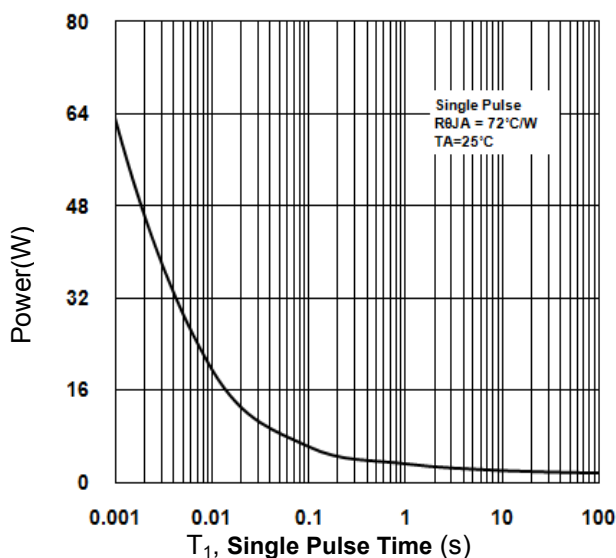


Fig5. Single Pulse Maximum Power Dissipation

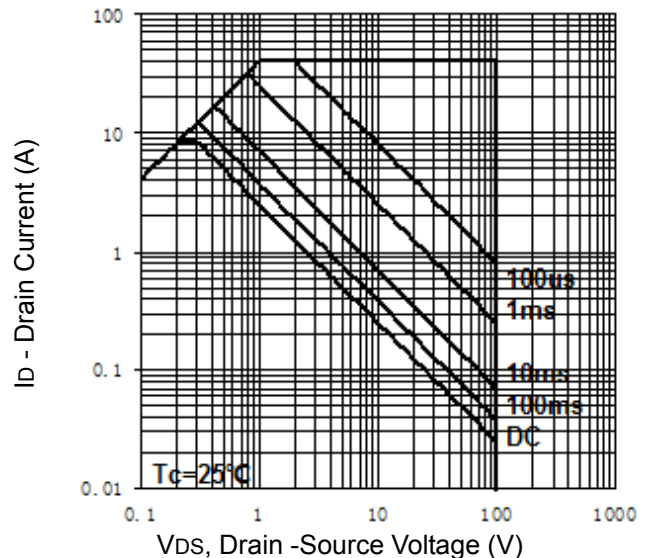


Fig6. Maximum Safe Operating Area

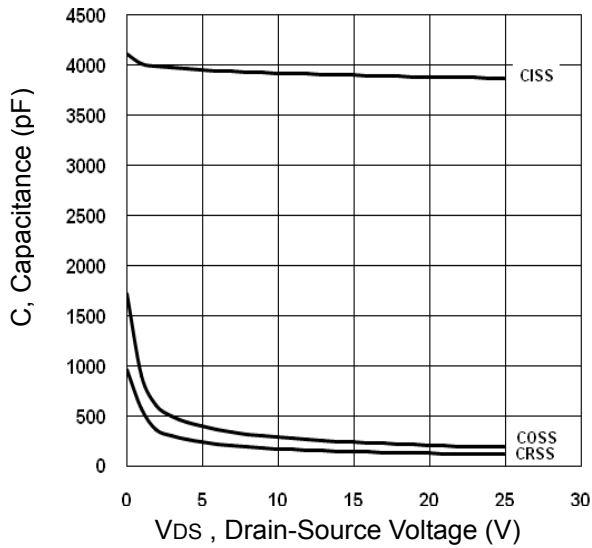


Fig7. Typical Capacitance Vs.Drain-Source Voltage

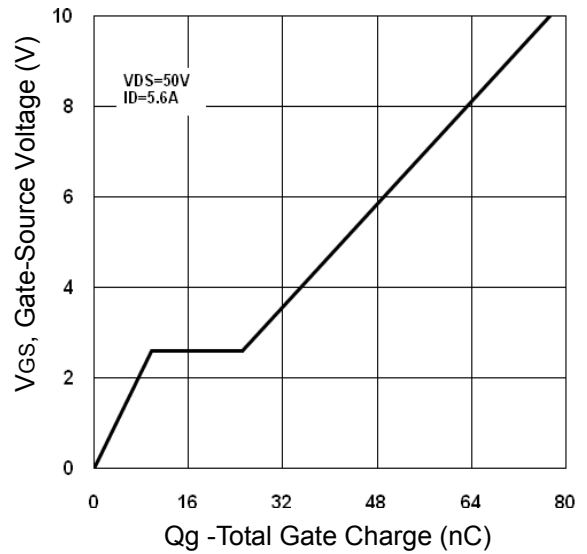


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

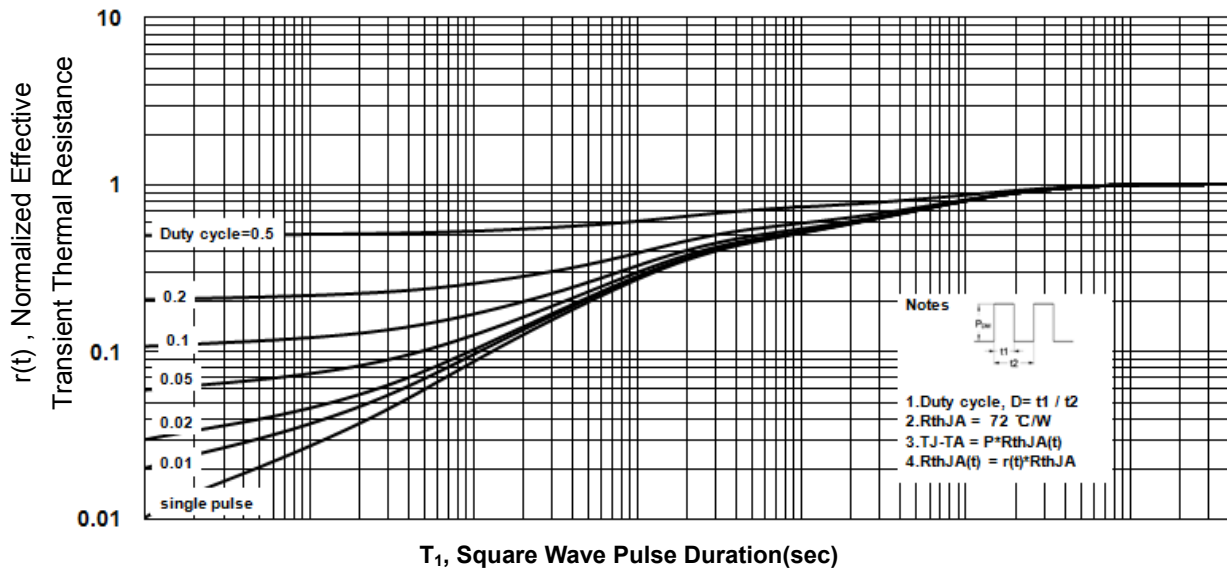


Fig9. T1 ,Transient Thermal Response Curve

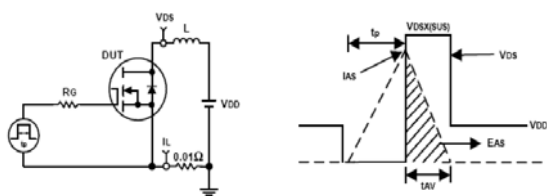


Fig10. Unclamped Inductive Test Circuit and waveforms

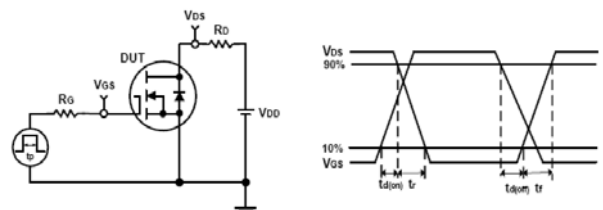
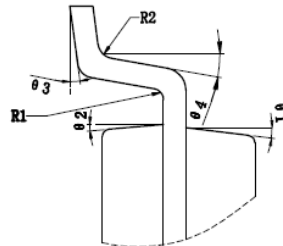
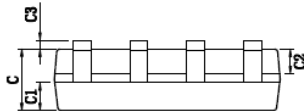
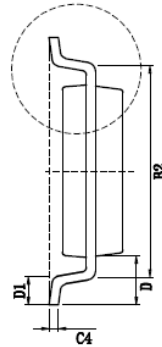
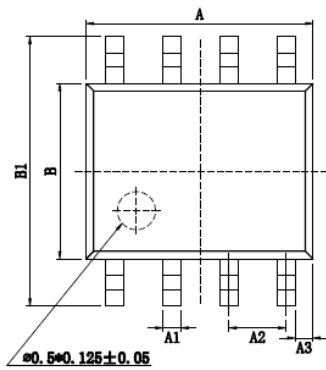


Fig11. Switching Time Test Circuit and waveforms

SOP8 Package Outline



Symbol	Dimensions In Millimeters		
	Min	Nom	Max
A	4.800	4.900	5.000
A1	0.356	0.406	0.456
A2	1.270Typ.		
A3	0.345Typ.		
B	3.800	3.900	4.000
B1	5.800	6.000	6.200
B2	5.00Typ.		
C	1.300	1.400	1.500
C1	0.550	0.600	0.650
C2	0.550	0.600	0.650
C3	0.050	--	0.200
C4	0.203Typ.		
D	1.050Typ.		
D1	0.400	0.500	0.600
R1	0.200Typ.		
R2	0.200Typ.		
$\theta 1$	17°Typ.		
$\theta 2$	13°Typ.		
$\theta 3$	0°~ 8°Typ.		
$\theta 4$	4°~ 12°Typ.		

Customer Service

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